A product Line of
Diodes Incorporated

PI3PCIE3442A

3.3V PCI Express® 3.0 2-Lane Exchange Switch

Features

- 8 Differential Channel (2-lane) Exchange
- PCI Express® 3.0 performance, 8.0 Gbps
- Bi-directional operation
- Low Bit-to-Bit Skew: 10ps (between ± signals)
- Low Crosstalk: -29dB @ 2.5GHz (5Gbps)
  -20dB @ 4.0GHz (8Gbps)
- Low Insertion Loss: -1.1dB @ 2.5GHz (5Gbps)
  -1.45dB @ 4.0GHz (8Gbps)
- V_{DD} Operating Range: 3.3V ±10%
- Industrial Temperature Range: -40°C to 85°C
- ESD Tolerance: 2kV HBM
- Packaging (Pb-free & Green):
  - 42-contact, TQFN (ZH42), 3.5x9mm.
  - 40-contact, TQFN (ZL40), 3x6mm.

Description

Diodes' PI3PCIE3442A is a differential exchange switch featuring pass-through pinout. It supports two full PCI Express® lanes operating at 8.0Gbps PCIe® 3.0 performance.

With the select control input low, Port A connects to Port B, and Port C connects to port D for an 8-channel differential pass-though. When the select control input is high Port A connects to Port D, and Port B connects to Port C.

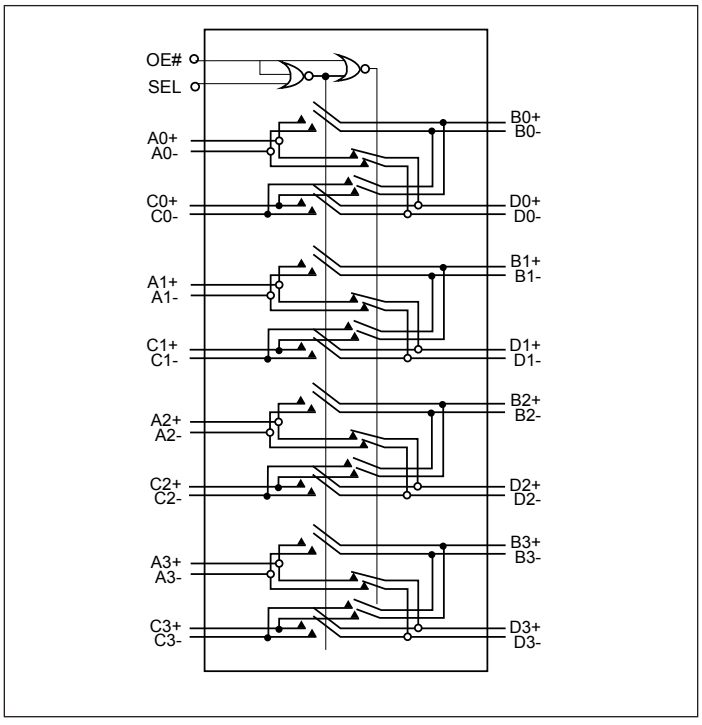
Application

Switching 4 lanes of DP1.2 from PC/Notebook/Tablet to Display monitor

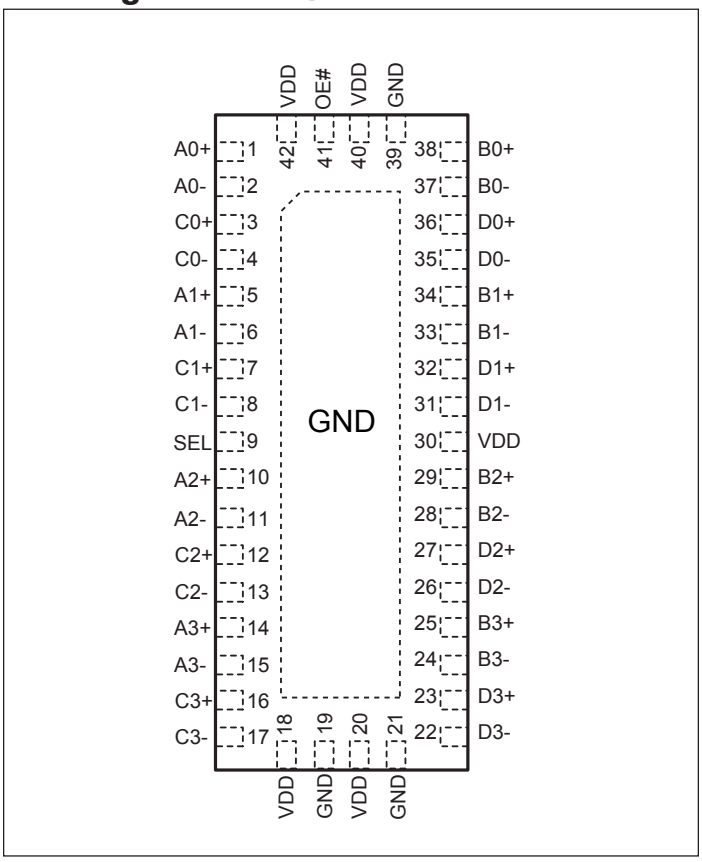
Truth Table

Function	SEL	OE#
Ax = Bx Cx = Dx	0	0
Ax = Dx Cx = Bx	1	0
Ax, Bx, Cx, Dx = Hi-Z (disconnect)	x	1

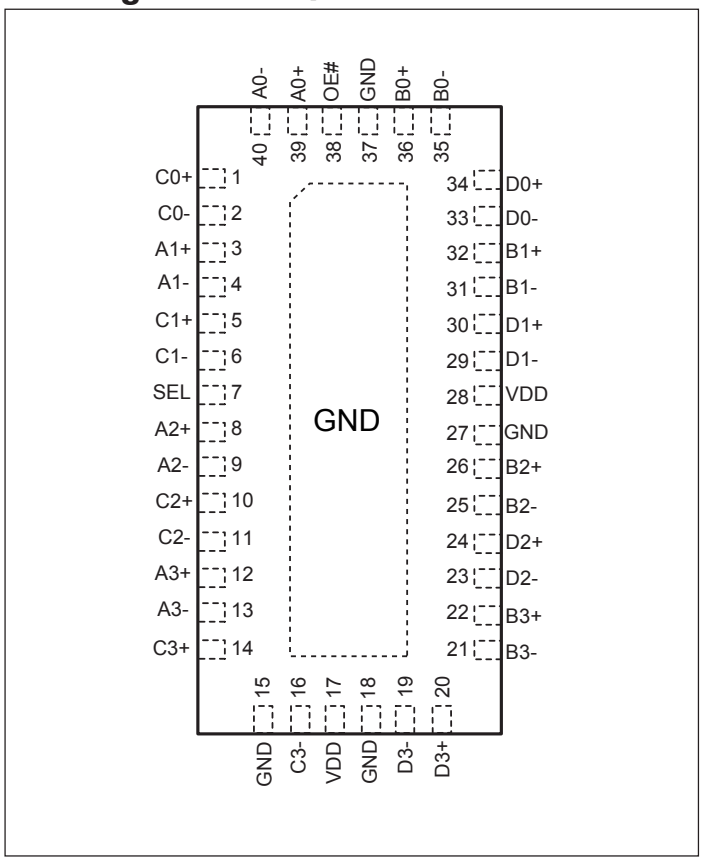
Block Diagram



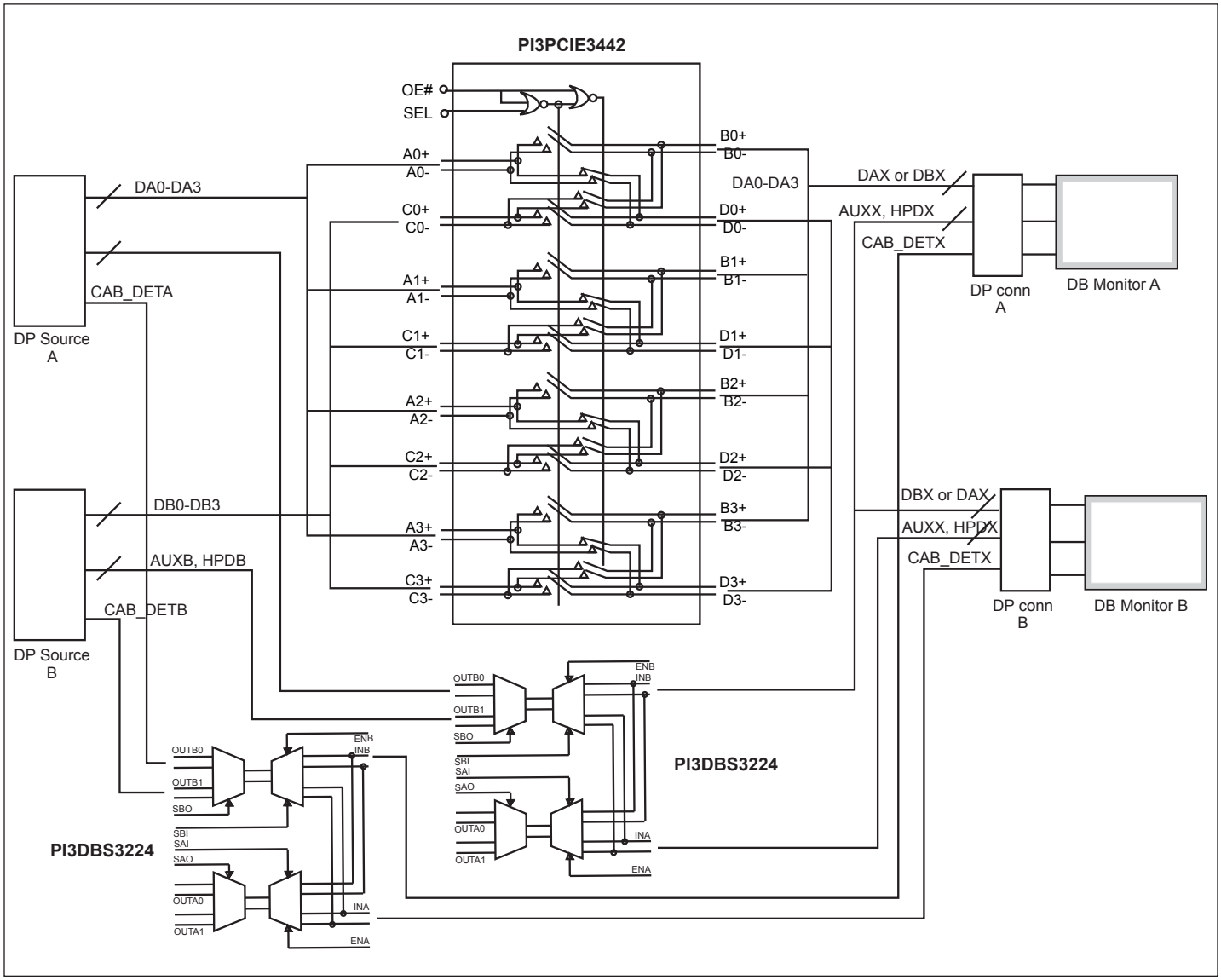
Pin Diagram 42-TQFN



Pin Diagram 40-TQFN



Application Diagram



Generic 2 x 2 DP1.2 Switching Using PI3PCIE3442A (3x6mm 40 pad QFN)

Pin Description (42-TQFN)

Pin #	Pin Name	I/O	Description
1	A0+	I/O	Signal I/O, Channel 0, Port A
2	A0–		
5	A1+	I/O	Signal I/O, Channel 1, Port A
6	A1–		
10	A2+	I/O	Signal I/O, Channel 2, Port A
11	A2–		
14	A3+	I/O	Signal I/O, Channel 3, Port A
15	A3–		
38	B0+	I/O	Signal I/O, Channel 0, Port B
37	B0–		
34	B1+	I/O	Signal I/O, Channel 1, Port B
33	B1–		
29	B2+	I/O	Signal I/O, Channel 2, Port B
28	B2–		
25	B3+	I/O	Signal I/O, Channel 3, Port B
24	B3–		
3	C0+	I/O	Signal I/O, Channel 0, Port C
4	C0–		
7	C1+	I/O	Signal I/O, Channel 1, Port C
8	C1–		
12	C2+	I/O	Signal I/O, Channel 2, Port C
13	C2–		
16	C3+	I/O	Signal I/O, Channel 3, Port C
17	C3–		
36	D0+	I/O	Signal I/O, Channel 0, Port D
35	D0–		
32	D1+	I/O	Signal I/O, Channel 1, Port D
31	D1–		
27	D2+	I/O	Signal I/O, Channel 2, Port D
26	D2–		
23	D3+	I/O	Signal I/O, Channel 3, Port D
22	D3–		
41	OE#	I	Output Enable, active low. When OE# = 0 the device I/O is enabled. When OE#=1, all I/O are high impedance
9	SEL	I	Operation mode Select (when SEL=0: A→B, C→D, when SEL=1: A→D, C→B)
18, 20, 30, 40, 42	V_{DD}	Pwr	3.3V ±10% Positive Supply Voltage
19, 21, 39, Center Pad	GND	Pwr	Power ground

Pin Description (40-TQFN)

Pin #	Pin Name	I/O	Description
39	A0+	I/O	Signal I/O, Channel 0, Port A
40	A0–		
3	A1+	I/O	Signal I/O, Channel 1, Port A
4	A1–		
8	A2+	I/O	Signal I/O, Channel 2, Port A
9	A2–		
12	A3+	I/O	Signal I/O, Channel 3, Port A
13	A3–		
36	B0+	I/O	Signal I/O, Channel 0, Port B
35	B0–		
32	B1+	I/O	Signal I/O, Channel 1, Port B
31	B1–		
26	B2+	I/O	Signal I/O, Channel 2, Port B
25	B2–		
22	B3+	I/O	Signal I/O, Channel 3, Port B
21	B3–		
1	C0+	I/O	Signal I/O, Channel 0, Port C
2	C0–		
5	C1+	I/O	Signal I/O, Channel 1, Port C
6	C1–		
10	C2+	I/O	Signal I/O, Channel 2, Port C
11	C2–		
14	C3+	I/O	Signal I/O, Channel 3, Port C
16	C3–		
34	D0+	I/O	Signal I/O, Channel 0, Port D
33	D0–		
30	D1+	I/O	Signal I/O, Channel 1, Port D
29	D1–		
24	D2+	I/O	Signal I/O, Channel 2, Port D
23	D2–		
20	D3+	I/O	Signal I/O, Channel 3, Port D
19	D3–		
38	OE#	I	Output Enable, active low. When OE# = 0 the device I/O is enabled. When OE#=1, all I/O are high impedance
7	SEL	I	Operation mode Select (when SEL=0: A→B, C→D, when SEL=1: A→D, C→B)
17, 28	V_{DD}	Pwr	3.3V ±10% Positive Supply Voltage
15, 18, 27, 37, Center Pad	GND	Pwr	Power ground

Maximum Ratings

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	–65°C to +150°C
Supply Voltage to Ground Potential	–0.5V to +3.7V
DC Input Voltage	–0.5V to V_{DD}
DC Output Current	120mA
Power Dissipation	0.5W
Junction Temperature	125°C

Note: Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Electrical Characteristics Recommended Operating Conditions

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
V_{DD}	3.3V Power Supply		3.0	3.3	3.6	V
I_{DD}	Total current from V_{DD} 3.3V supply	SEL and OE# at OV or V_{DD}			300	µA
T_A	Operating temperature range		-40		85	°C

DC Electrical Characteristics for Switching over Operating Range

Parameters	Description	Test Conditions(1)	Min.	Typ.(1)	Max.	Units
V_{IH}	Input HIGH Voltage	Guaranteed HIGH level	0.65 x V_{DD}			V
V_{IL}	Input LOW Voltage	Guaranteed LOW level	–0.5		0.35 x V_{DD}	
V_{IK}	Clamp Diode Voltage	V_{DD} = Max., I_{IN} = –18mA		–0.7	–1.2	
I_{IH}	Input HIGH Current, SEL	V_{DD} = Max., V_{IN} = V_{DD}	–10		+10	µA
I_{IL}	Input LOW Current, SEL	V_{DD} = Max., V_{IN} = GND	–10		+10	
IIH	Input HIGH Current, A_X, B_X, C_X, D_X	V_{DD} = Max., V_{IN} = 1.8V	–10		+10	µA
I_{IL}	Input LOW Current, A_X, B_X, C_X ,D_X	V_{DD} = Max., V_{IN} = 0V	–10		+10	

Note:

1. Typical values are at VDD = 3.3V, TA = 25°C ambient and maximum loading.

Switching Characteristics

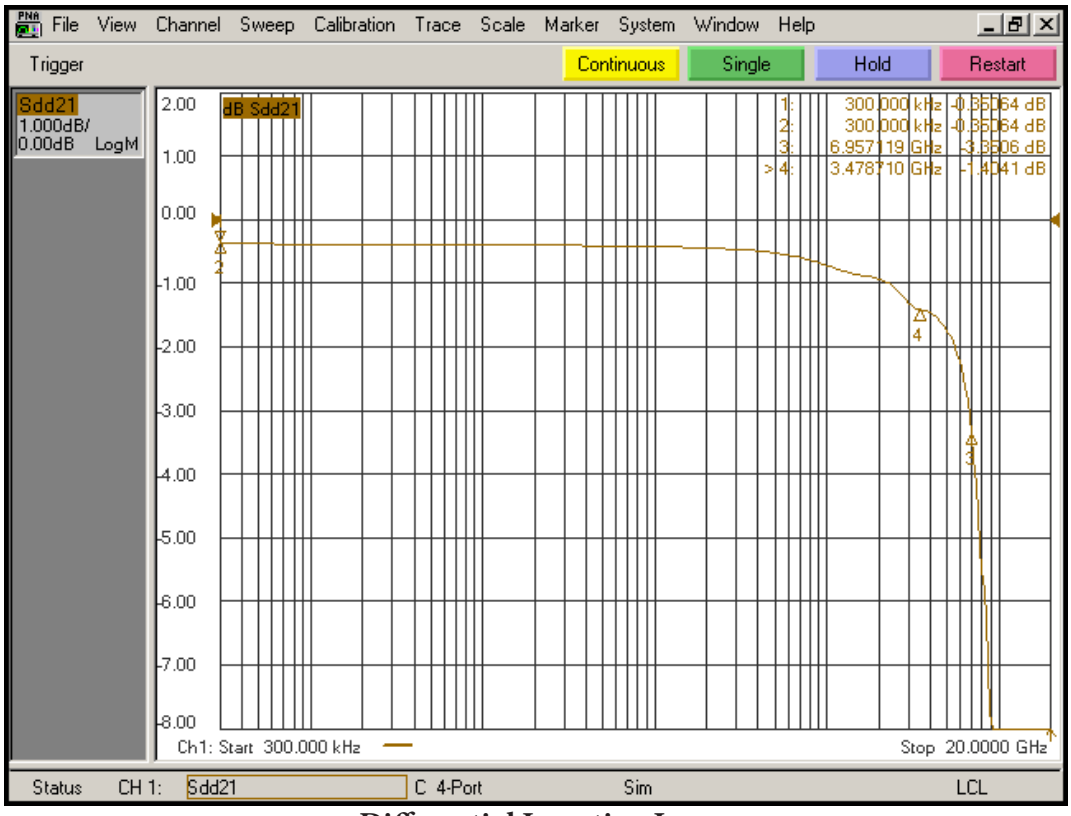
Parameters	Description	Test Conditions	Min.	Typ.	Max.	Units
t_{PZH}, t_{PZL}	Line Enable Time - SEL to A_N, B_N, C_N, D_N		0.5		45	ns
t_{PHZ}, t_{PLZ}	Line Disable Time - SEL to A_N, B_N, C_N, D_N		0.5		25	
t_{b-b}	Bit-to-bit skew within the same differential pair				10	ps
t_{ch-ch}	Channel-to-channel skew				20	

Dynamic Electrical Characteristics

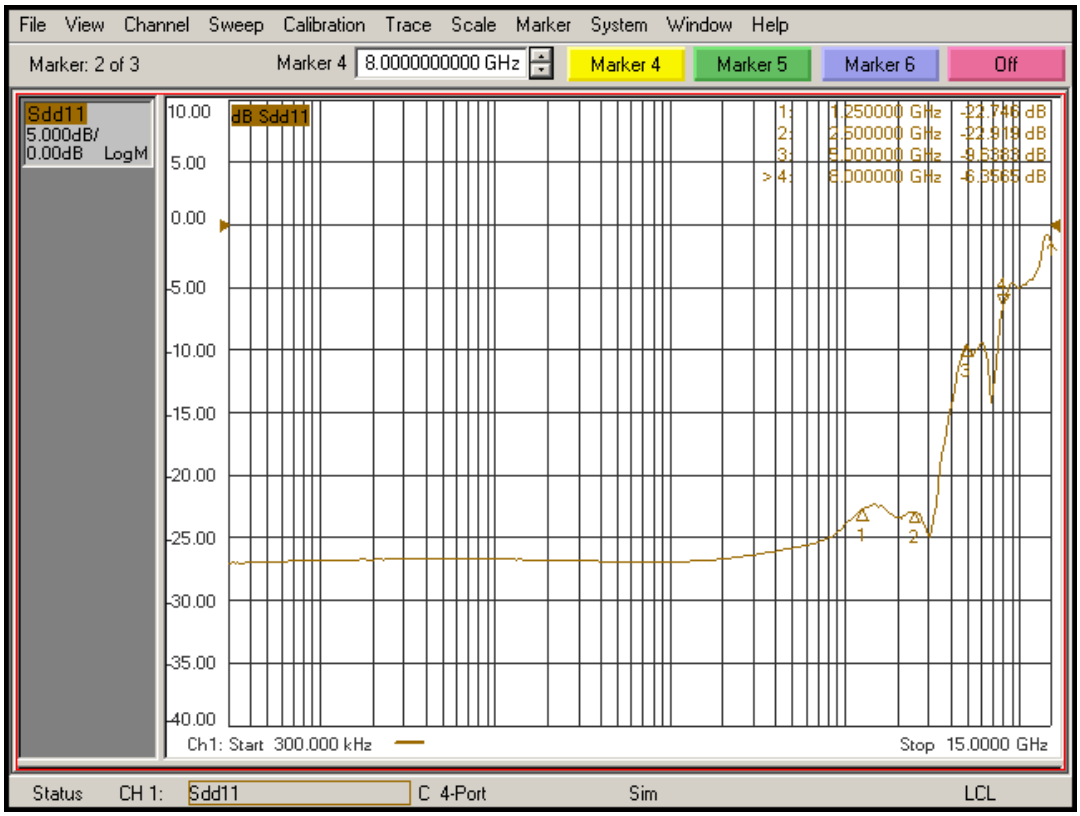
Parameter	Description	Test Conditions	Min.	Typ.(1)	Max.	Units
DDIL	Differential Insertion Loss (V_{IN} = -10dBm, DC = 0V)	f=1.2GHz		-0.8	-1.0	dB
		f=2.5GHz		-1.0	-1.2	
		f=4.0GHz		-1.3	-1.9	
		f=5.0GHz		-1.8	-2.6	
		f=7.5GHz		-4.5	-5.6	
$DDIL_{OFF}$	Differential Off Isolation	f= 4.0GHz		-19		dB
DDRL	Differential Return Loss	f= 0 to 2.8GHz		-26		dB
		f= 2.8 to 5.0GHz		-14		
		f= 5.0 to 8.0GHz		-7.5		
DDNEXT	Near End Crosstalk	f= 0 to 2.8GHz		-26		dB
		f= 2.8 to 5.0GHz		-20		
		f= 5.0 to 8.0GHz		-16		
$V_{I F}$	Max Signal Frequency Range	Insertion loss 1.5dB, V_{IN}=0.623Vpp, DC=0V		4.0		GHz
		Insertion loss 1.5dB, V_{IN}=0.623Vpp, DC=0.9V		4.0		
		Insertion loss 3dB, V_{IN}=0.623Vpp, DC=0V		8.0		
		Insertion loss 3dB, V_{IN}=0.623Vpp, DC=0.9V		8.0		
BW	-3dB Bandwidth			6.5		GHz

Notes:

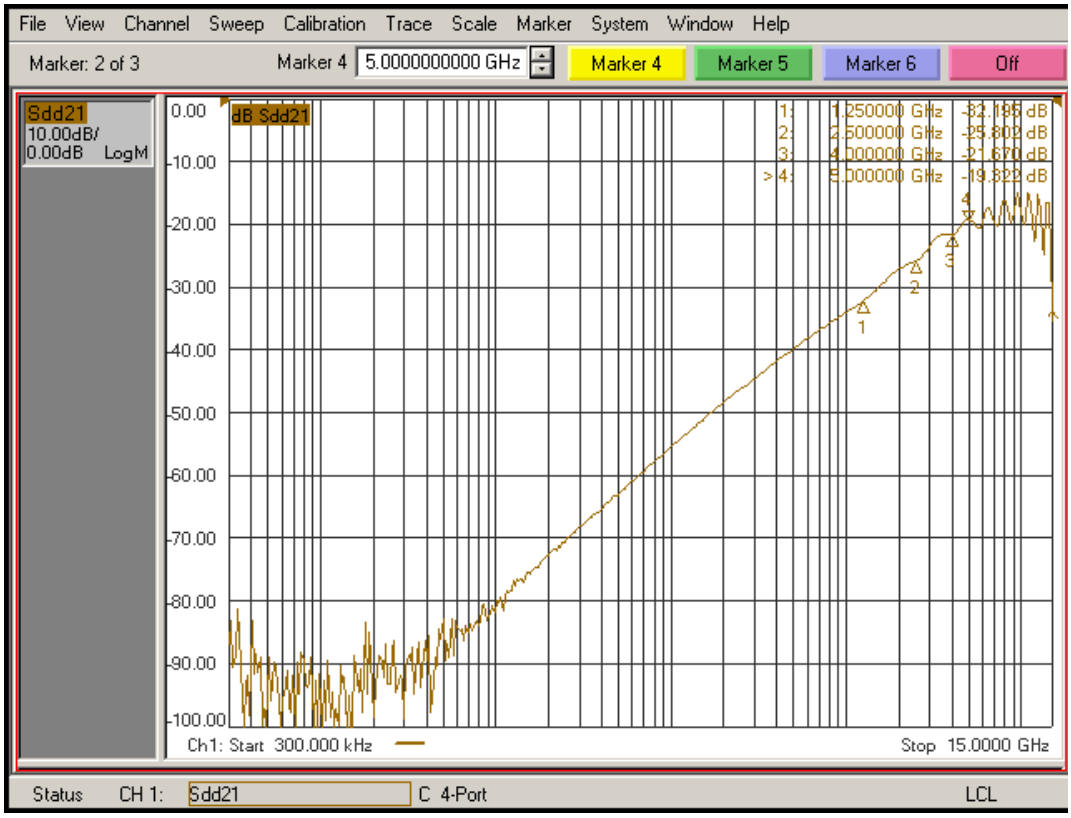
1. Guaranteed by design. Typical values are at V_{DD} = 3.3V , T_A = 25°C ambient and maximum loading.



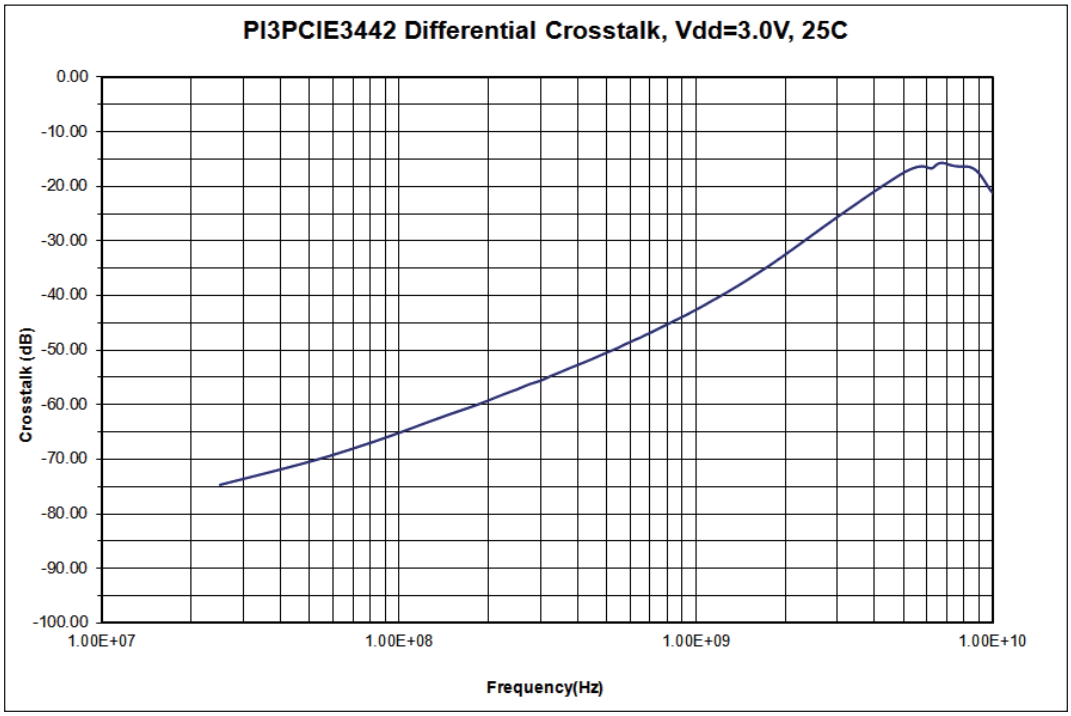
Differential Insertion Loss



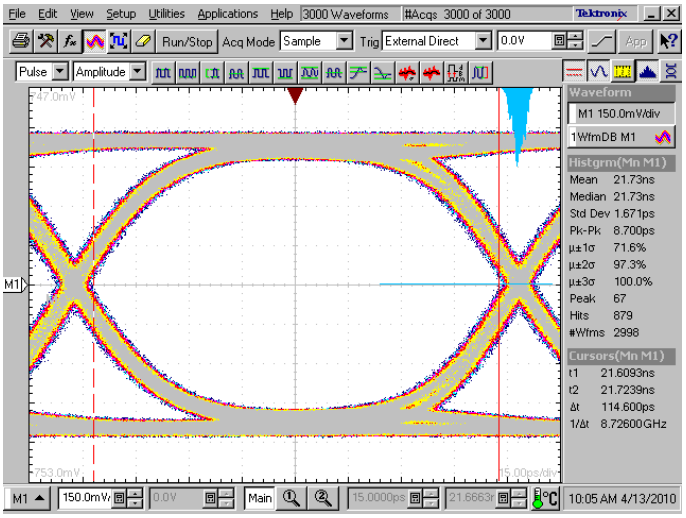
Differential Return Loss



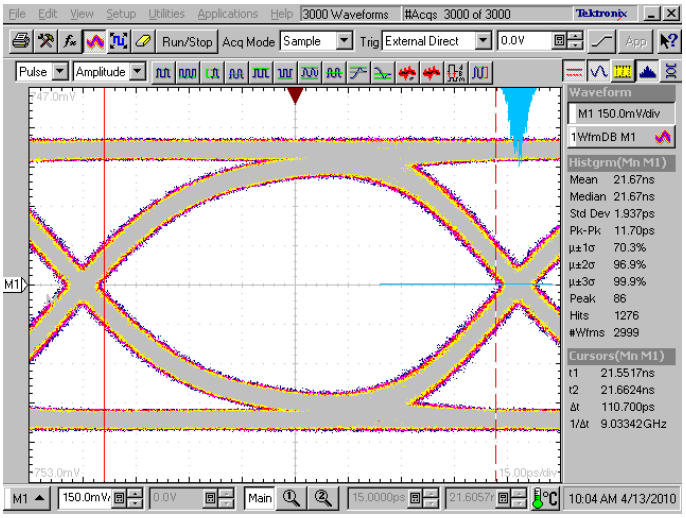
Differential Off Isolation



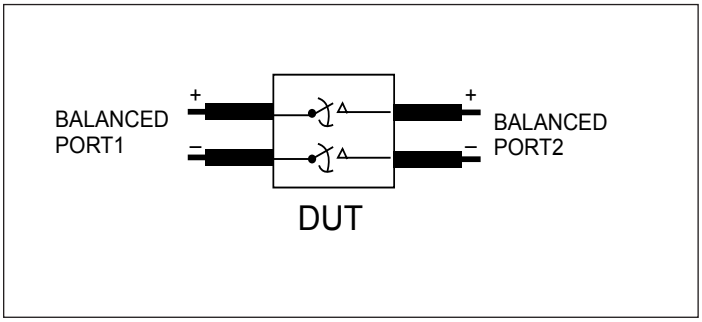
Differential Crosstalk



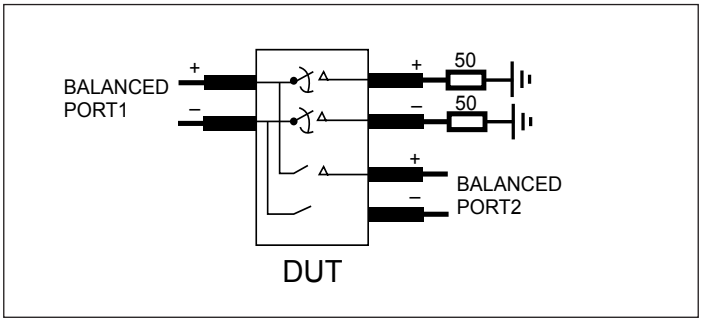
8.0 Gbps RX signal eye without PI3PCIE3442A



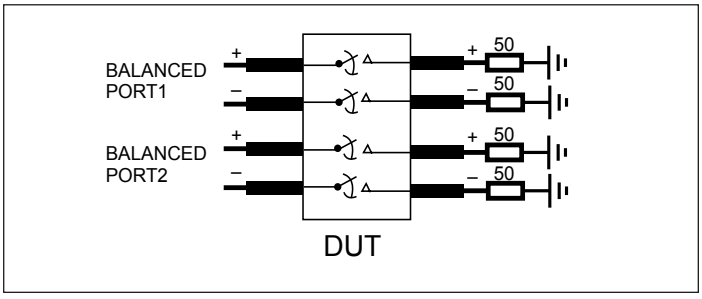
8.0 Gbps RX signal eye with PI3PCIE3442A



Differential Insertion Loss and Return Test Circuit

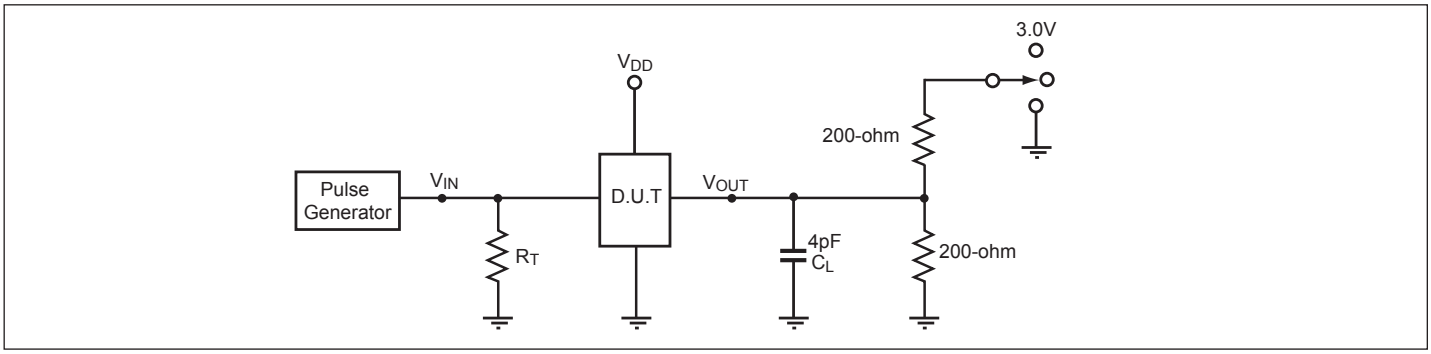


Differential Off Isolation Test Circuit



Differential Near End Xtalk Test Circuit

Test Circuit for Electrical Characteristics(1-5)



Notes:

1. C_L = Load capacitance: includes jig and probe capacitance.

2. R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator

3.Output 1 is for an output with internal conditions such that the output is low except when disabled by the output control. output 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

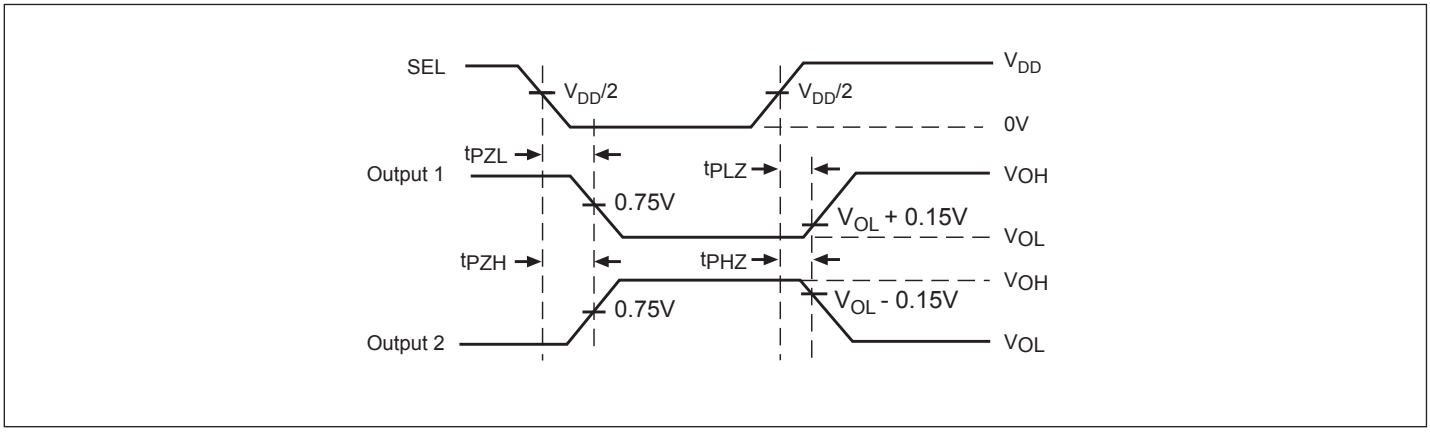
4. All input impulses are supplied by generators having the following characteristics: PRR ≤ MHz, $Z_O = 50\Omega$, $t_R \leq 2.5$ns, $t_F \leq 2.5$ns.

5. The outputs are measured one at a time with one transition per measurement.

Switch Positions

Test	Switch
t_{PLZ}, t_{PZL}	3.0V
t_{PHZ}, t_{PZH}	GND
Prop Delay	Open

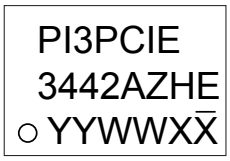
Switching Waveforms



Voltage Waveforms Enable and Disable Times

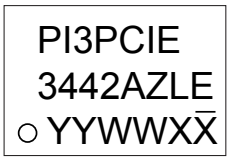
Part Marking Information

ZH Package



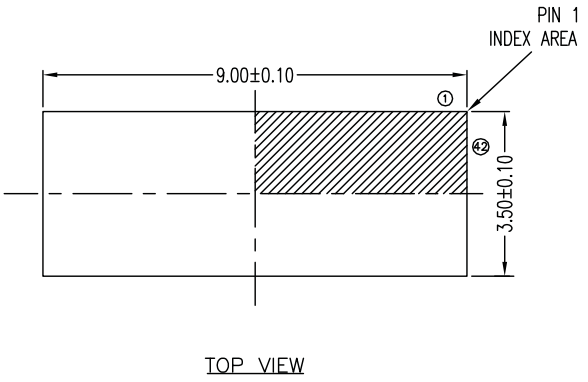
YY : Year
WW : Workweek
1st X: Assembly Code
2nd X: Fab Code

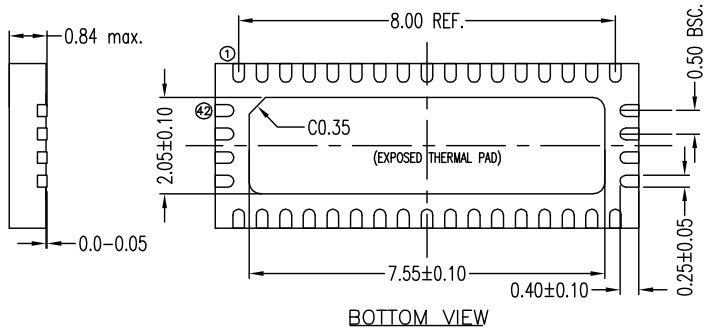
ZL Package

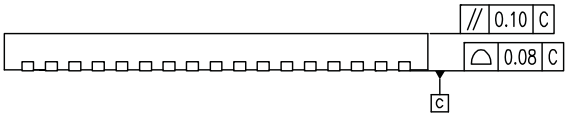


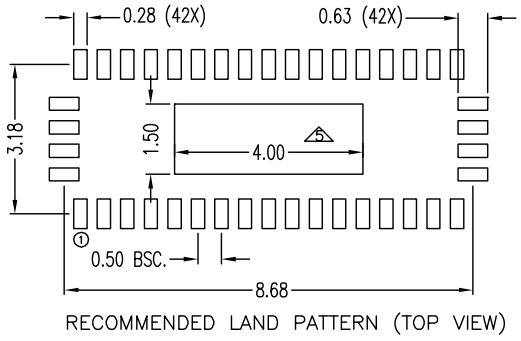
YY : Year
WW : Workweek
1st X: Assembly Code
2nd X: Fab Code

Packaging Mechanical: 42-Contact TQFN (3.5x9mm)









Notes:
1. All dimensions are in millimeters, angles in degrees.
2. Coplanarity applies to the exposed thermal pad as well as the terminals.
3. Refer JEDEC MO-220
4. Recommended Land Pattern is for reference only.
5. Thermal Pad Soldering Area

PERICOM Semiconductor Corporation — DATE: 02/17/09

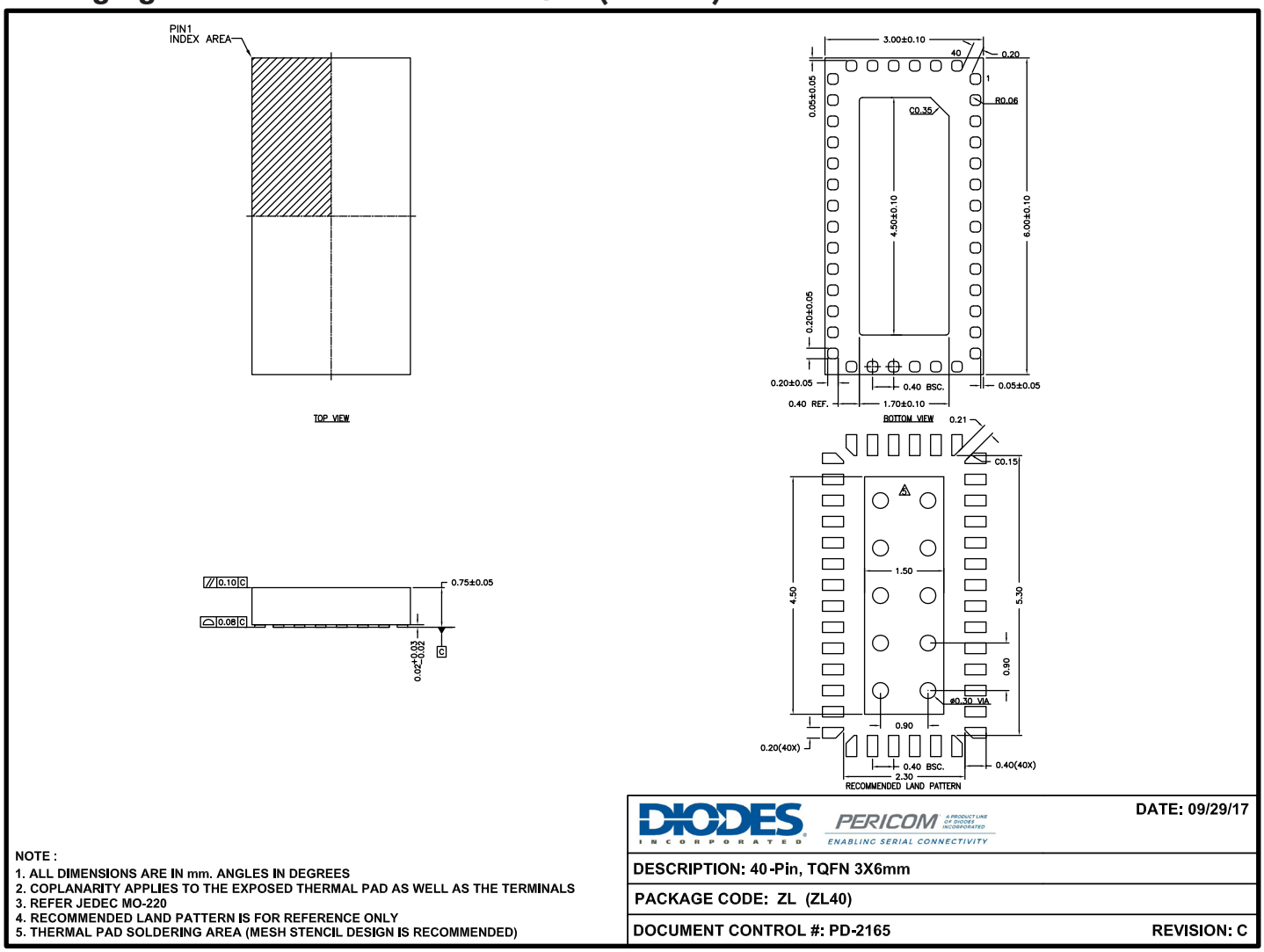
DESCRIPTION: 42-contact Thin Fine Pitch Quad Flat No-Lead (TQFN)

PACKAGE CODE: ZH (ZH42)

DOCUMENT CONTROL #: PD-2035 — REVISION: C

09-0116

Packaging Mechanical: 40-Contact TQFN (3x6mm)



NOTE :
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES
2. COPLANARITY APPLIES TO THE EXPOSED THERMAL PAD AS WELL AS THE TERMINALS
3. REFER JEDEC MO-220
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY
5. THERMAL PAD SOLDERING AREA (MESH STENCIL DESIGN IS RECOMMENDED)

DIODES INCORPORATED | PERICOM A PRODUCT LINE OF DIODES INCORPORATED — ENABLING SERIAL CONNECTIVITY

DATE: 09/29/17

DESCRIPTION: 40-Pin, TQFN 3X6mm

PACKAGE CODE: ZL (ZL40)

DOCUMENT CONTROL #: PD-2165 REVISION: C

17-0681

For latest package info.
please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Code	Package Code	Package Description
PI3PCIE3442AZHEX	ZH	42-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN)
PI3PCIE3442AZLEX	ZL	40-contact, 3 x 6mm (TQFN)

Notes:

- Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel

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B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

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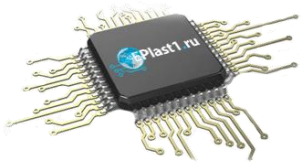
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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